

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C		
20V	0.4Ω @ V _{GS} = 4.5V	1.3A		
	0.5Ω @ V _{GS} = 2.5V	1.2A		
	0.7Ω @ V _{GS} = 1.8V	1.0A		

Features and Benefits

- Footprint of just 0.6mm² Thirteen Times Smaller than SOT23
- 0.4mm Profile Ideal for Low Profile Applications
- Low Gate Threshold Voltage
- · Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2451UFB4Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Load Switch

Mechanical Data

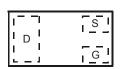
- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.001 grams (Approximate)

X2-DFN1006-3

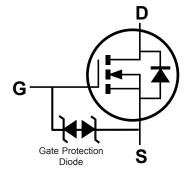




Bottom View



Top View Internal Schematic



Equivalent Circuit

Ordering Information (Note 4)

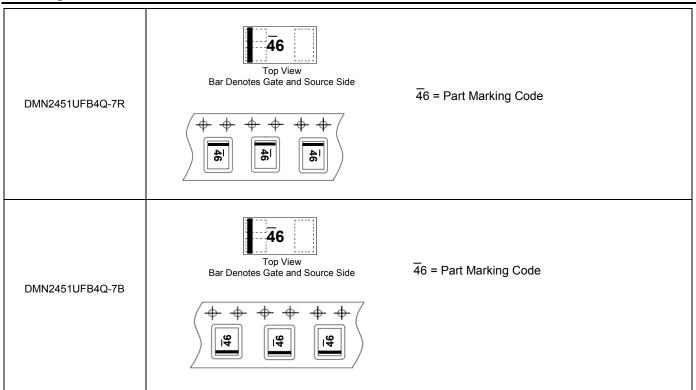
Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Tape Pitch (mm)	Packaging
DMN2451UFB4Q-7B	46	7	8	2	10,000/Reel
DMN2451UFB4Q-7R	46	7	8	4	3,000/Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information





Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			I _D	1.3 1.0	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	3	Α

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P_{D}	0.66	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	189	°C/W
Total Power Dissipation (Note 6)	P _D	1.1	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	113	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

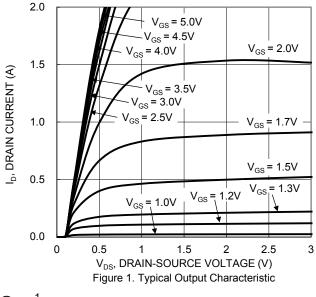
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	V _{GS} = 0V, I _D = 250μA	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	100	nA	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±1.0	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.5	_	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		_	0.26	0.4	Ω	V _{GS} = 4.5V, I _D = 600mA	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	0.35	0.5		V _{GS} = 2.5V, I _D = 500mA	
		_	0.5	0.7		V _{GS} = 1.8V, I _D = 350mA	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	V _{GS} = 0V, I _S = 150mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	32	_	pF		
Output Capacitance	Coss	_	5.5	_	pF	$V_{DS} = 16V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	3.7	_	pF	- 1.0WH2	
Gate Resistance	Rg	_	86	_	Ω	V _{DS} = 0V, V _{GS} = 0V	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	3.4	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	6.4	_	nC	V _{DS} = 10V,	
Gate-Source Charge	Q _{gs}	_	0.4	_	nC	I _D = 250mA	
Gate-Drain Charge	Q_{gd}	_	1.3	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	5.5	_	ns		
Turn-On Rise Time	t _R	_	2.9	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	11	_	ns	$R_L = 47\Omega, R_g = 10\Omega,$ $I_D = 200\text{mA}$	
Turn-Off Fall Time	t _F	_	12	_	ns		

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm X 25mm square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





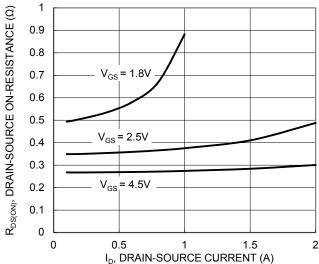


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

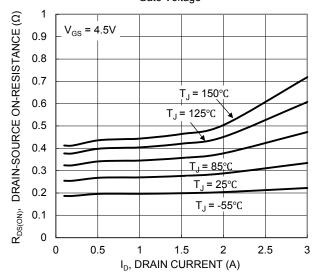
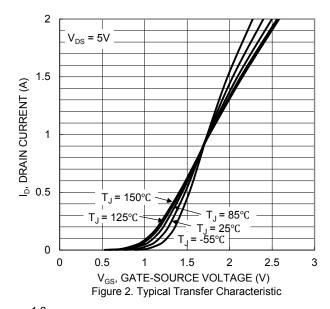
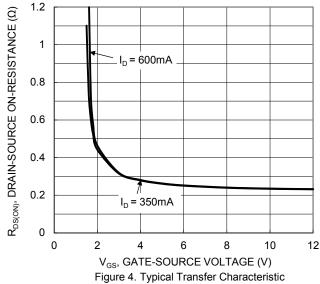


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





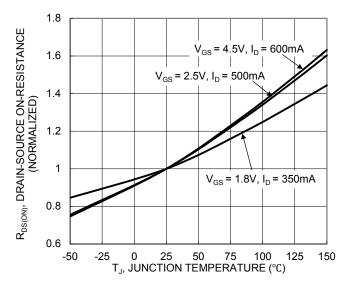


Figure 6. On-Resistance Variation with Junction Temperature



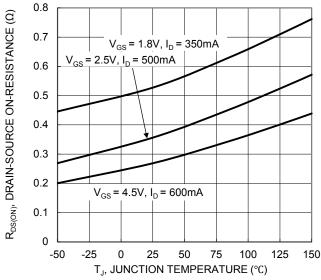


Figure 7. On-Resistance Variation with Junction

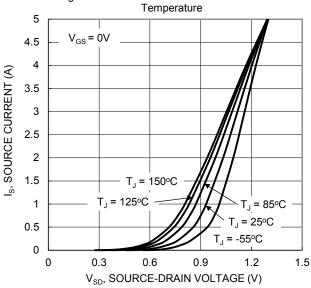


Figure 9. Diode Forward Voltage vs. Current

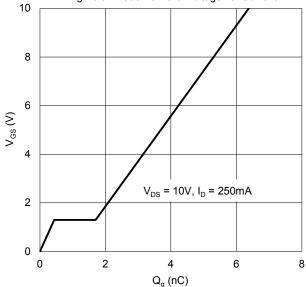


Figure 11. Gate Charge

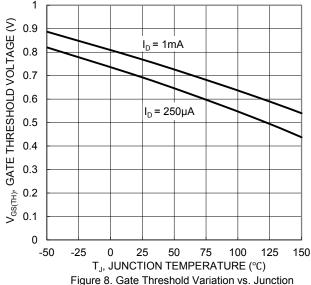


Figure 8. Gate Threshold Variation vs. Junction Temperature

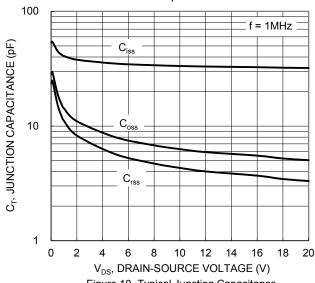
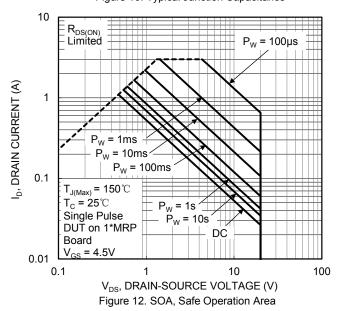


Figure 10. Typical Junction Capacitance



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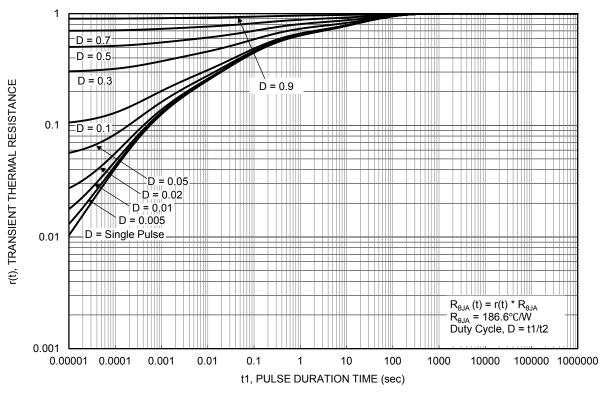


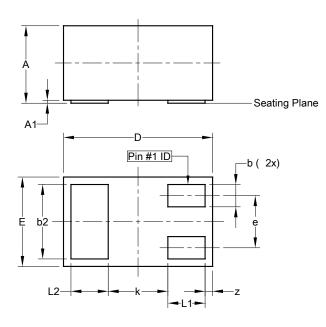
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

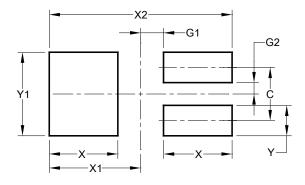


X2-DFN1006-3					
Dim	Min	Max	Тур		
Α	_	0.40	_		
A1	0.00	0.05	0.03		
b	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.05	1.00		
Е	0.55	0.65	0.60		
е	-	-	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
k	-	-	0.40		
Z	0.02	0.08	0.05		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3



Dimensions	Value (in mm)			
С	0.350			
G1	0.150			
G2	0.075			
X	0.450			
X1	0.600			
X2	1.200			
Y	0.200			
Y1	0.550			



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